3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

1. Product Number

H 2 U 1 4 W 1 H 1 A 0 4 0 0



2. Features

- *Stable and reliable in performances
- *Low temperature coefficient of frequency
- *Low profile, compact size
- *RoHS 2.0 compliance
- *SMT processes compatible
- *AEC-Q200 compliant

3. Applications

*GNSS (Global Navigation Satellite System)

*Hand-held devices when GPS& BDS & GLONASS & Galileo functions are needed, e.g., PDA, Smart phone, PND.

4. Description

Unictron's AA088 ceramic chip antenna is designed for GNSS band applications, covering frequencies 1560~1606 MHz. Fabricated with proprietary design and processes, AA088 shows excellent performance and is fully compatible with SMI corp processes which can decrease the assembly cost and improve device's quality and consistency.

Document Control Cent



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by: Jane Designed by: Sam Checked by: Mike Approved by: Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

DOCUMENT NO.

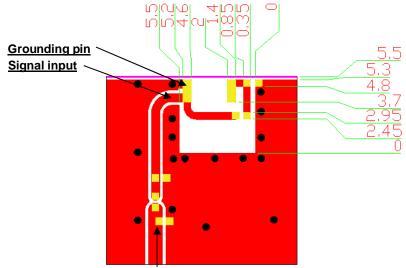
H2U14W1H1A0400

5. Layout Guide & Electrical Specifications

5-1. Layout Guide (unit: mm)

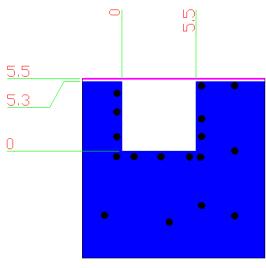
Solder Land Pattern:

The solder land pattern (gold marking areas) is shown below. Recommendation on matching circuit will be provided according to customer's installation conditions.



Transmission Line with 50Ω Impedance Characteristic

Top View



Bottom View

Unictron
Technologies Corp.

2020-07-02

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

DOCUMENT NO.

H2U14W1H1A0400

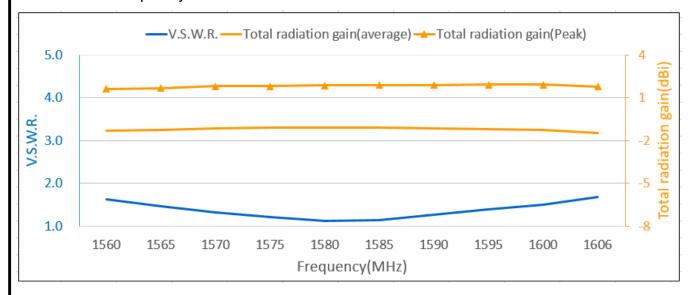
5-2. Electrical Specifications (Evaluation Board Dimensions: 80 x 40 mm²)

5-2-1. Electrical Table

Characteristics	Specifications	Unit
Outline Dimensions	3.2 x 1.6 x 0.5	mm
Ground Plane Dimensions	80 x 40	mm
Working Frequency	1560~1606	MHz
VSWR (@ center frequency)*	2 Max. (typical)	
Characteristic Impedance	50	Ω
Polarization	Linear Polarization	
Peak Gain (@1575.42MHz)	1.8 (typical**)	dBi
Efficiency (© 1373.42W112)	77 (typical**)	%

^{*}Center frequency means the frequency with the lowest value in return loss of the chip antenna on the evaluation board..

5-2-2. Frequency vs. V.S.W.R. and Total Radiation Gain



Unictron
Technologies Corp.

2020-07-02

Document

Unictron
Technologies Corp.

詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by: Jane Designed by: Sam Checked by: Mike Approved by: Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

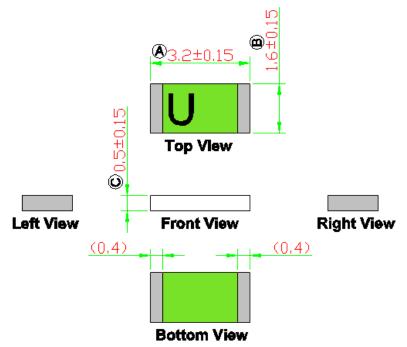
DOCUMENT NO.

H2U14W1H1A0400

^{**}A typical value is for reference only, not guaranteed.

6. Antenna Dimensions & Test Board (unit: mm)

6-1. Antenna Dimensions



NOTE:

1.All materials are RoHS compliant. 2."♠~©" Critical Dimensions. 3."()" Reference Dimensions.

PIN Definitions





PIN	1	2
Soldering PAD	Signal	Tuning / Ground

Unictron
Technologies Corp.

2020-07-02

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by: Jane Designed by: Sam Checked by: Mike Approved by: Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

DOCUMENT NO.

H2U14W1H1A0400

6-2. Evaluation Board with Antenna



Unit: mm

Unictron
Technologies Corp.

2020-07-02

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna

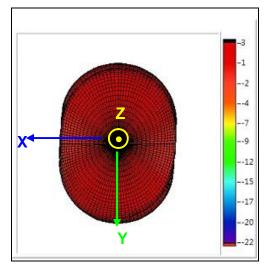
(AA088) Engineering Specification

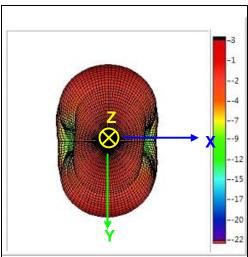
DOCUMENT NO.

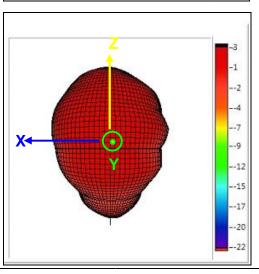
H2U14W1H1A0400

7. Radiation Pattern (80 x 40 mm² ground plane)

7-1. 3D Gain Pattern @ 1561 MHz (unit: dBi)











詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

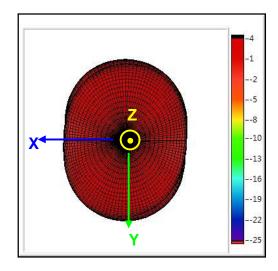
Prepared by: Jane Designed by: Sam Checked by: Mike Approved by: Herbert

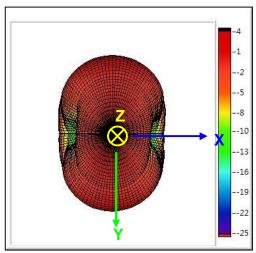
TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

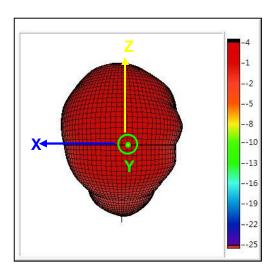
DOCUMENT NO.

H2U14W1H1A0400

7-2. 3D Gain Pattern @ 1575.42 MHz (unit: dBi)









Unictron
Technologies Corp.

詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

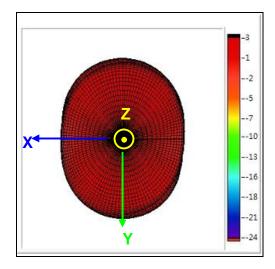
Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert

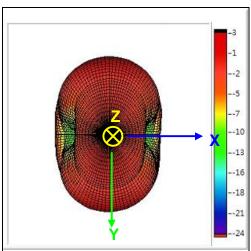
TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

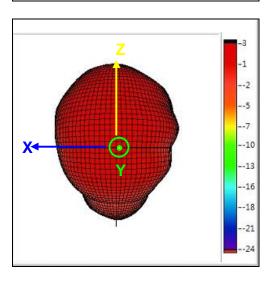
DOCUMENT NO.

H2U14W1H1A0400

7-3. 3D Gain Pattern @ 1590 MHz (unit: dBi)











詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

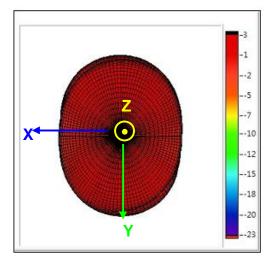
Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert

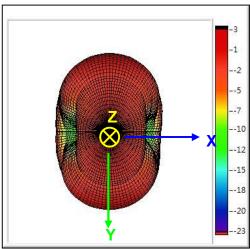
TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

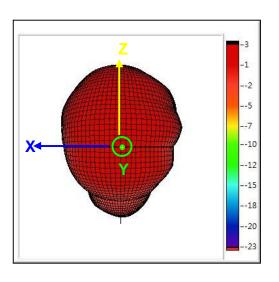
DOCUMENT NO.

H2U14W1H1A0400

7-4. 3D Gain Pattern @ 1602 MHz (unit: dBi)









Unictron Technologies Corp.

詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

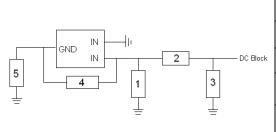
DOCUMENT NO.

H2U14W1H1A0400

8. Frequency tuning and Matching circuit 8-1. Chip antenna tuning scenario: . 5. Fine tuning element Signal Input 4. Fine tuning element Matching circuit Unictron Technologies Corp. 2020-07-02 THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES 詠業科技股份有限公司 CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR **Unictron Technologies Corporation** SALE OF APPARATUS OR DEVICES WITHOUT Website:www.unictron.com PERMISSION Prepared by : Jane Designed by: Sam Checked by: Mike Approved by : Herbert **DOCUMENT** TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna REV. H2U14W1H1A0400 (AA088) Engineering Specification NO. PAGE 10 OF 20

8-2. Matching circuit:

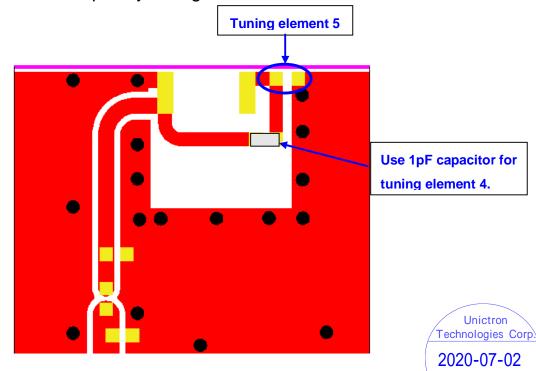
With the following recommended values of matching and tuning components, the Center frequency will be about 1575.42 MHz at our standard 80 x 40 mm² evaluation board. However, these are typical reference values which may need to be changed when circuit boards or part vendors are different.



System Matching Circuit Component			
Location	Description	Vendor	Tolerance
1	1.5 pF,(0402)	Murata	±0.05pF
2	0Ω		
3	3.3 pF,(0402)	Murata	±0.05pF
Fine tuning element 4	1 pF, (0402)	Murata	±0.05pF
Fine tuning element 5	2.7 pF, (0402)	Murata	±0.05pF

Typical reference values which may need to be changed when circuit boards or part vendors are different.

8-3. Reference for frequency tuning element 5



Unictron
Technologies Corp.

詠業科技股份有限公司

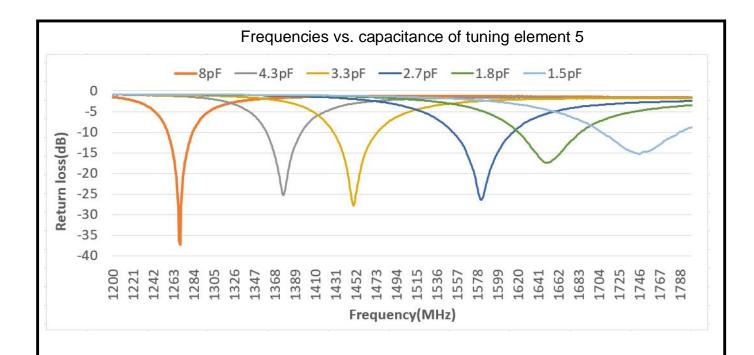
Unictron Technologies Corporation Website:www.unictron.com THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

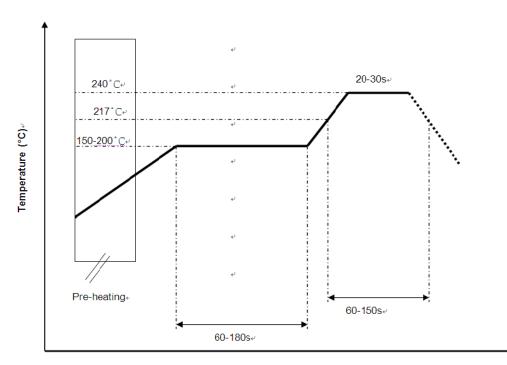
DOCUMENT NO.

H2U14W1H1A0400



9. Soldering Conditions

a. Typical Soldering Profile for Lead-free Process



Time (s.)₽

Unictron
Technologies Corp.

*Recommended solder paste alloy: SAC305 (Sn96.5 /Ag3 /Cu0.5) Lead Free solder paste.

2020-07-02

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

DOCUMENT NO.

H2U14W1H1A0400

10. Reminders for users of Unictron's chip antennas

- a. Since Unictron's chip antennas are made of ceramic materials which show different rigidity than circuit board materials, bending of circuit board at the locations where chip antennas are mounted may cause the cracking of solder joints or antenna itself.
- b. Any connecting strip which will be cut off at PCB assembly process shall be located away from the installation site of chip antenna. Punching of the connecting strip may cause severe bending of the circuit board and cracking of solder joint or chip antenna itself may occur.
- c. Be cautious when ultrasonic welding process needs to be used near the locations where chip antennas are installed. Strong ultrasonic vibration may cause the cracking of chip antenna solder joints.

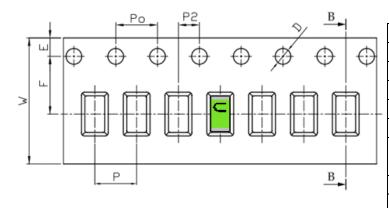
11. Packing

(1) Quantity/Reel: 5000 pcs/Reel

(2) Plastic tape:

a. Tape Drawing

b. Tape Dimensions (unit: mm)



Feature	Specifications	Tolerances
W	12.00	±0.30
Р	4.00	±0.10
Е	1.75	±0.10
F	5.50	±0.10
P2	2.00	±0.10
D	1.50	+0.10
D 1.50	-0.00	
Po	4.00	±0.10
10Po	40.00	±0.20

c. Reel Drawing

Unictron
Technologies Corp.

2020-07-02

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

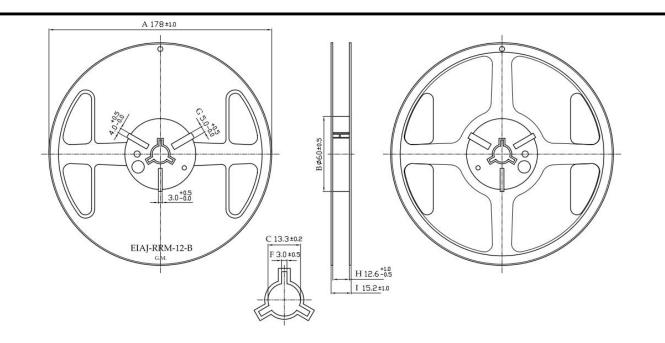
THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert

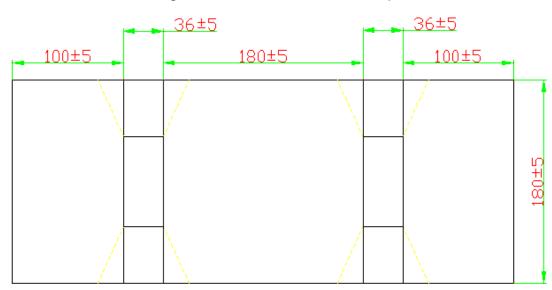
TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

DOCUMENT NO.

H2U14W1H1A0400



d. Drawing of small size carton in developed view



e. Drawing of middle size carton in developed view

Unictron
Technologies Corp.

2020-07-02

Document ontrol Cente



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

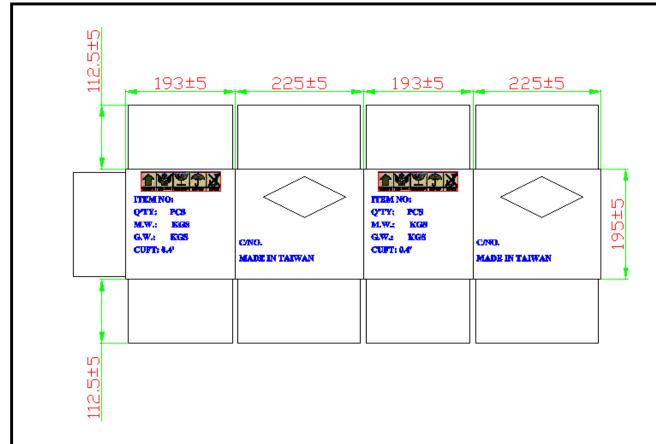
THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert

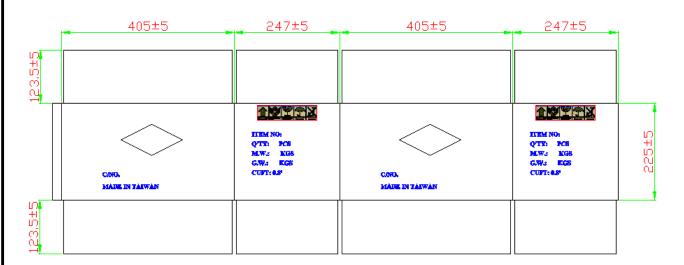
TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

DOCUMENT NO.

H2U14W1H1A0400



f. Drawing of large size carton in developed view



Unictron
Technologies Corp.

2020-07-02

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

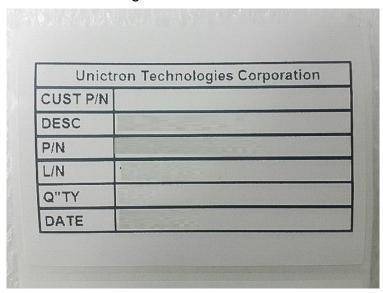
Prepared by: Jane Designed by: Sam Checked by: Mike Approved by: Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

DOCUMENT NO.

H2U14W1H1A0400

g. Picture of label



h. Reel with label



Unictron
Technologies Corp.

2020-07-02

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

ip Antenna DOCUMENT NO.

H2U14W1H1A0400

i. Small size carton with label



i. Middle size carton with label



Unictron
Technologies Corp.

2020-07-02

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

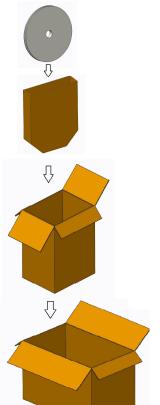
Prepared by: Jane Designed by: Sam Checked by: Mike Approved by: Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

DOCUMENT NO.

H2U14W1H1A0400

11-2. Process of packing



1 reel includes 5,000pcs(max.) chip antennas

1 small size carton includes 2pcs(max.) reels

1 middle size carton includes 5pcs(max.) small catons

1 large size carton includes 2pcs(max.) middle cartons

12. Operating & Storage Conditions

12-1. Operating

(1) Maximum Input Power: 2 W

(2) Operating Temperature: -40°C to 85°C

(3) Relative Humidity: 10% to 70%

12-2. Storage (sealed)

(1) Storage Temperature: -5° C to 40° C

(2) Relative Humidity: 20% to 70%

(3) Shelf Life: 1 year

12-3. Storage (unsealed)

Meet the criteria of <u>J-STD-033 MSL2a</u>

Unictron
Technologies Corp.

2020-07-02

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by: Jane Designed by: Sam Checked by: Mike Approved by: Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

DOCUMENT NO.

H2U14W1H1A0400

12-4. Storage (After mounted on customer's PCB with SMT process)

(1) Storage Temperature: -40 $^{\circ}$ C to 85 $^{\circ}$ C

(2) Relative Humidity: 10% to 70%

13. Notice

(1) Installation Guide:

Please refer to Unictron's application note "General guidelines for the installation of Unictron's chip antennas" for further information.

(2) All specifications are subject to change without notice.

Unictron
Technologies Corp.

2020-07-02

Document Control Cent



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

DOCUMENT NO.

H2U14W1H1A0400

14. Reliability Test

Test Items	Test Conditions	Result
1. Solderability	*Solder Temperature: 250 ± 5°C	
	*Test time: 2 +/- 0.5 sec	Pass
	*With solder paste	
2. Temperature cycling	-40°C/ 30min~90°C /30min	
	Total 100 cycles	
	* Specimens are kept at standard	Pass
	measurement environment for more than	
	24 hours before testing.	
3. Damp heat	*Humidity:90~95%	
	*Temperature: 85°C	
	*Test time: 240 hours	Pass
	* Specimens are kept at standard	r ass
	measurement environment for more than	
	24 hours before testing	
4. Adhesive strength of	* Resistance to bending of printed-circuit	
terminal electrodes	test board(110x40x1.6mm)	Pass
	* Applied force: 1Kgf;	r ass
	* Duration: 10±1sec	
5. High temperature exposure	*Temperature : 90°C	
	*Test duration: 240 hours	
	* Specimens are kept at standard	Pass
	measurement environment for more than	
	24 hours before testing.	
6. Low temperature exposure	*Temperature: -40°C	
	*Test duration: 240 hours	
	* Specimens are kept at standard	Pass
	measurement environment for more than	
	24 hours before testing.	

Unictron
Technologies Corp.

2020-07-02

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert

TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) Engineering Specification

DOCUMENT NO.

H2U14W1H1A0400